

## • General Description

The AGM100P35D combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{\text{DS(ON)}}$ .

This device is ideal for load switch and battery protection applications.

#### Features

- Advance high cell density Trench technology
- $\blacksquare$  Low  $R_{\text{DS(ON)}}$  to minimize conductive loss
- Low Gate Charge for fast switching
- ■Low Thermal resistance
- 100% Avalanche tested
- 100% DVDS tested

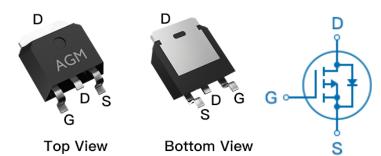
#### Application

- MB/VGA Vcore
- SMPS 2<sup>nd</sup> Synchronous Rectifier
- POL application
- BLDC Motor driver

# **Product Summary**

BVDSS	RDSON	ID
-100V	30mΩ	-40A

# **TO-252 Pin Configuration**



## **Package Marking and Ordering Information**

Device Mark	ng	Device	Device Packag	je	Reel Size	Tape width	Quantity
AGM100P35	D AG	M100P35D	TO-252		330mm	16mm	2500

#### Table 1. Absolute Maximum Ratings (TA=25℃)

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	-100	V
VGS	Gate-Source Voltage (VDS=0V)	±20	V
ID	Drain Current-Continuous(Tc=25℃) (Note 1)	-40	А
טו	Drain Current-Continuous(Tc=100°ℂ)	-27	А
IDM (pluse)	Drain Current-Pulsed (Note 2)	-160	А
	Maximum Power Dissipation(Tc=25℃)	100	W
PD	Maximum Power Dissipation(Tc=100℃)	50	W
EAS	Avalanche energy (Note 3)	160	mJ
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 175	$^{\circ}$ C

#### Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) <sup>1</sup>		50	°C/W
RθJC	Thermal Resistance Junction-Case <sup>1</sup>		1.5	°C/W



Table 3. Electrical Characteristics (TJ=25℃unless otherwise noted)

Symbol	Electrical Characteristics (TJ=25℃ unio Parameter	Conditions	Min	Тур	Max	Unit
On/Off Sta	ites					
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=-250μA	-100			V
IDSS	Zero Gate Voltage Drain Current	VDS=-100V,VGS=0V			-1	μA
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V			±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=-250μA	-1.2		-2.2	V
gFS	Forward Transconductance	VDS=-5V,ID=-5A		35		S
RDS(on)	Drain-Source On-State Resistance	VGS=-10V, ID=-15A		30	40	mΩ
		VGS=-4.5V, ID=-10A		36	50	mΩ
Dynamic C	Characteristics					
Ciss	Input Capacitance	\/D0_40\/\/00_0\/		1400		pF
Coss	Output Capacitance	VDS=-40V,VGS=0V ,F=1MHZ		315		pF
Crss	Reverse Transfer Capacitance			14		pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz		5.5	-	Ω
Switching	Times					
td(on)	Turn-on Delay Time			5.8		nS
tr	Turn-on Rise Time	VGS=-10V,VDS=-50V,		14		nS
td(off)	Turn-Off Delay Time	ID=-15A,RGEN=3Ω		28		nS
tf	Turn-Off Fall Time			26		nS
Qg	Total Gate Charge			23		nC
Qgs	Gate-Source Charge	VGS=-10V, VDS=-50V, ID=-15A		11		nC
Qgd	Gate-Drain Charge	- 100 000, 15 10, 1		4.9		nC
Source-Dr	ain Diode Characteristics					
ISD	Source-Drain Current(Body Diode)				-40	Α
VSD	Forward on Voltage	VGS=0V,IS=-15A			-1.2	V
trr	Reverse Recovery Time	Isd=-15A ,		53		ns
Qrr	Reverse Recovery Charge	dl/dt=100A/µs , TJ=25℃		103	-	nc

Notes 1. The maximum current rating is package limited.

Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

Notes 3.EAS condition: TJ=25℃



#### **Typical Electrical and Thermal Characteristics**

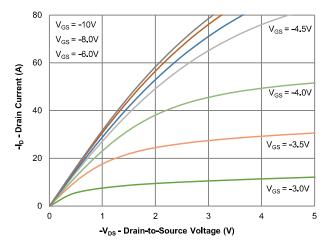


Figure 1: Output Characteristics

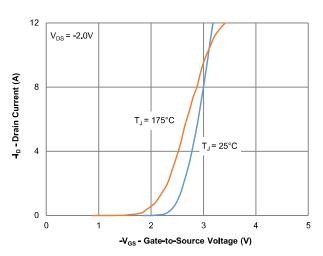


Figure 2: Transfer Characteristics

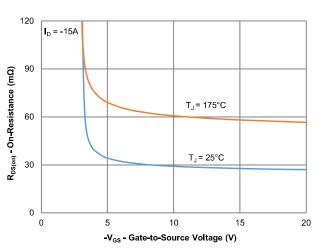


Figure 3: On-Resistance vs. Gate-Source Voltage

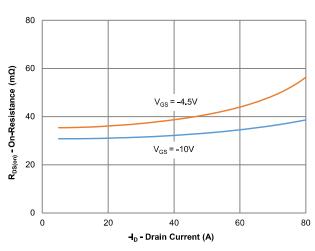


Figure 4: On-Resistance vs. Gate-Source Voltage

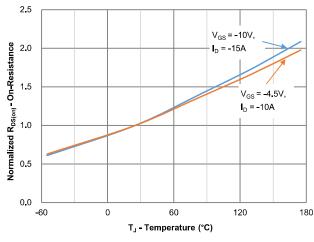


Figure 5: On-Resistance vs. Junction Temperature

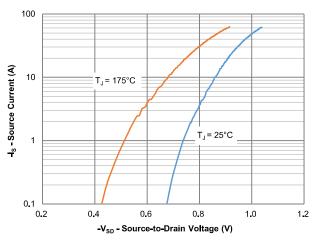


Figure 6: Source-Drain Diode Forward Voltage



## **Typical Electrical and Thermal Characteristics**

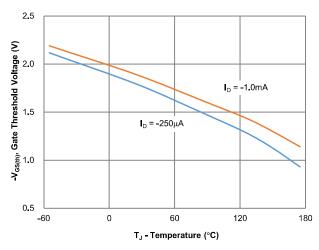


Figure 7: Gate Threshold Variation vs. Junction Temperature

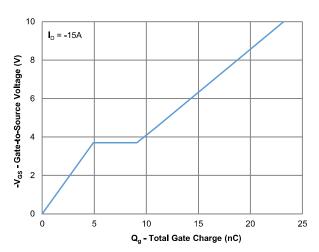


Figure 8: Gate Charge Characteristics

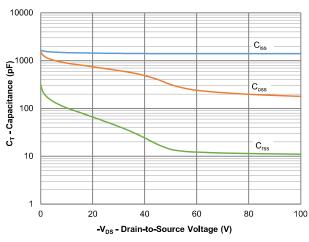


Figure 9: Capacitance Characteristics

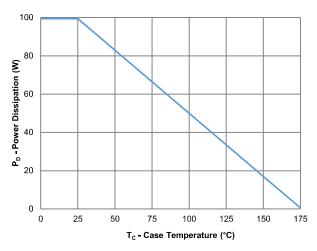


Figure 10: Power Derating

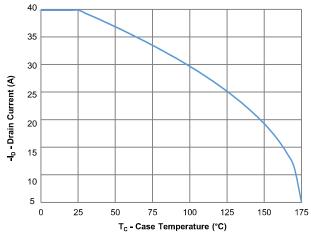


Figure 11: Current Derating

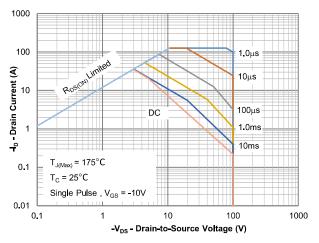


Figure 12: Safe Operating Area



# **Typical Electrical and Thermal Characteristics**

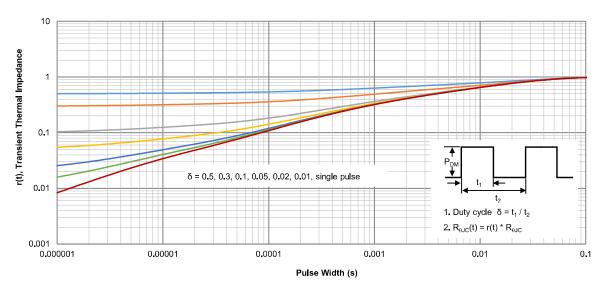
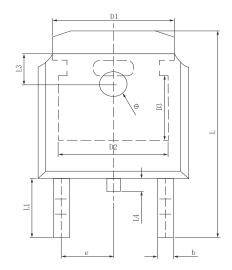
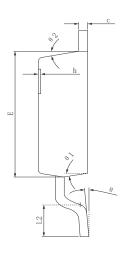


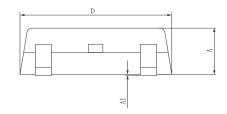
Figure 13: Normalized Maximum Transient Thermal Impedance

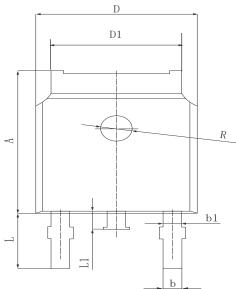


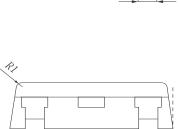
# •Dimensions (TO-252)

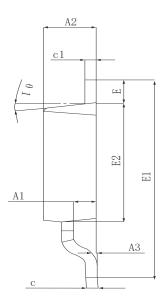


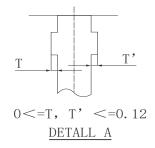






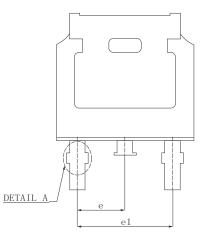






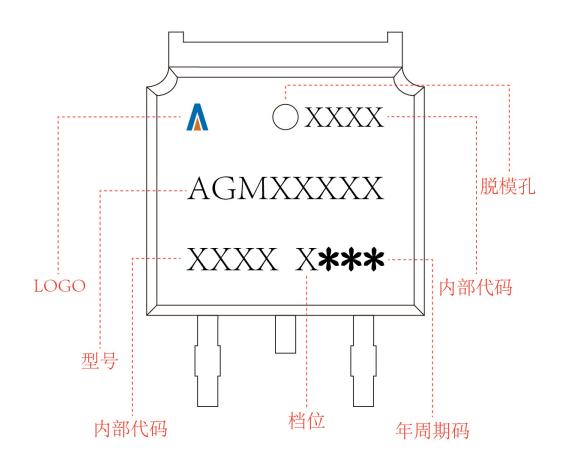
Olumoi.	MILLIMETER				
SYMBOL	MIN	Typ.	MAX		
A	2. 200	2.300	2.400		
A1	0.000		0.127		
b	0.640	0.690	0.740		
c(电镀后)	0.460	0.520	0.580		
D	6.500	6.600	6.700		
D1	5. 334 REF				
D2	4.826 REF				
D3	3.166 REF				
Е	6.000	6.100	6.200		
е		2.286 TYP			
h	0.000	0.100	0.200		
L	9.900	10.100	10.300		
L1	2.888 REF				
L2	1.400	1.550	1.700		
L3	1.600 REF				
L4	0.600	0.800	1.000		
Ф	1.100	1.200	1.300		
θ	0°		8°		
θ 1	9° TYP				
θ2	9° TYP				

SYMBOL	MILLIMETER				
	MIN	NOM	MAX		
A	7.050	7. 100	7. 150		
A1	0.960	1.010	1.060		
A2	2.250	2. 300	2. 350		
А3	0.000	0.050	0.100		
b	0.760REF.				
b1	1. 000REF.				
С	0. 508REF.				
c1	0. 508REF.				
D	6.550	6.600	6.650		
D1	5. 220	5. 320	5. 420		
Е	0.950	1.000	1.050		
E1	9.700	9.900	10.100		
E2	6.050	6. 100	6. 150		
е	2. 286BSC				
e1	4. 572REF.				
L	2.650	2.800	2.950		
L1	0.700	0.800	0.900		
θ 1	7° REF.				
R	1. 300REF.				
R1	0. 250REF.				





TO-252 Marking Instructions:





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